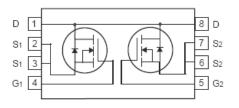


Dual N-Channel Enhancement Mode MOSFET

FEATURES

5A,20V.rds(on) = 0.025 Ω @ Vgs = 4.5 V rds(on) = 0.040 Ω @ Vgs = 2.5 V.



8205A N-Channel MOSFET



Absolute Maximum Ratings (TA=25oC, unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	VDS	20	V
Gate-Source Voltage	Vgs	<u>±</u> 8	V
Continuous Drain Current	ΙD	5	Α
Pulsed Drain Current	Ірм	20	Α
Maximum Power Dissipation TA = 25°C	Po	2.0	W
TA = 70°C	FD	1.6	W
Thermal Resistance,Junction-to-Ambient	R θ JA	78	°C/W
Thermal Resistance,Junction-to-Case	R θ JC	40	°C/W
Jumction temperature and Storage temperature	Tj.Tstg	-55 to +150	$^{\circ}$



$8205 A \ \ Electrical \ Characteristics \ (TA=25^{\circ}C, unless \ otherwise \ noted)$

Parameter	Symbol	Testconditons	Min	Тур	Max	Unit	
Drain-Source Breakdown Voltage	VDSS	VGS = 0 V, ID = 250 μ A	20			V	
Zero Gate Voltage Drain Current	Ipss	Vps = 20V , Vgs = 0V			1		
	IDSS	Vps = 20V , Vgs = 0V , TJ =55℃			5	· uA	
Gate-Body Leakage	Igss	V_{DS} = 0V , V_{GS} = $\pm 8V$			±50	nA	
Gat e Thres hol d V ol t age	GS(th) /	VDS = VGS , ID = 250uA	0. 5		1. 0	V	
Drain-Source On-State Resistance *		Vgs = 4.5V , b = 5A		0.020	0.025	Ω	
	rDS(on)	VGS = 2.5V , ID = 4A		0.035	0.040		
On-State Drain Current *	D(on)	VDS = 5V , V6S = 4.5V	15			Α	
Forward Transconductance *	gfs	Vps = 5V , Ip =3A		11		S	
Input Capacitance	Ciss	Vps = 10 V, Vgs = 0 V,f = 1.0 MHz		700		pF	
Output Capacitance	Coss			175		pF	
Reverse Transfer Capacitance	Crss			85		pF	
Total Gate Charge	Qg			7	10	nC	
Gate-Source Charge	Qgs	Vps = 10V , Vgs = 4.5V , Ip = 3A		1.2			
Gate-Drain Charge	Qgd			1.9			
Turn-On Delay Time	td(on)			8	16	ns	
Rise Time	tr	V _{DD} = 10V		10	18		
Turn-Off Delay Time	td(off)	ID = 1A , Vgs = 4.5V , Rg = 6 Ω		18	29		
Fall Time	tf			5	10		
Maximum Continuous Drain-Source Diode Forward Current	Is				1.3	Α	
Diode Forward Voltage *	VsD	Is = 1.7 A, VGS = 0 V		0.65	1.2	V	
		1					

^{*} Pulse test; pulse width \leqslant 300 $\,\mu$ s, duty cycle \leqslant 2 %.